

Date: ____ / ____ , 2012

To: Tokyo Electric Power Company, Inc. (hereinafter "TEPCO")

Subject: Handling of "the Document *Request for Proposals of Communication System for Smart Meters* and Related Information Provided by TEPCO" (hereinafter "RFP").

We hereby receive the RFP and pledge to abide by the following terms and conditions:

1. We undertake to treat as strictly confidential and not to divulge to any third party, directly or indirectly, the contents of the RFP.
2. We shall make no use, directly or indirectly, of the RFP furnished hereunder for any purpose other than RFP.
3. We do not file an application for any patent, utility model right and design right resulting from any invention, utility model, design which reflect or are based upon the contents of the RFP.
4. Upon request from TEPCO, we shall promptly destroy or return the RFP to TEPCO.
5. We agree that TEPCO shall not be liable for the accuracy, usefulness, or non-infringement of RFP.

Sincerely yours,

Company Name: _____

By: _____

(Signature)

Name: _____

Title: _____